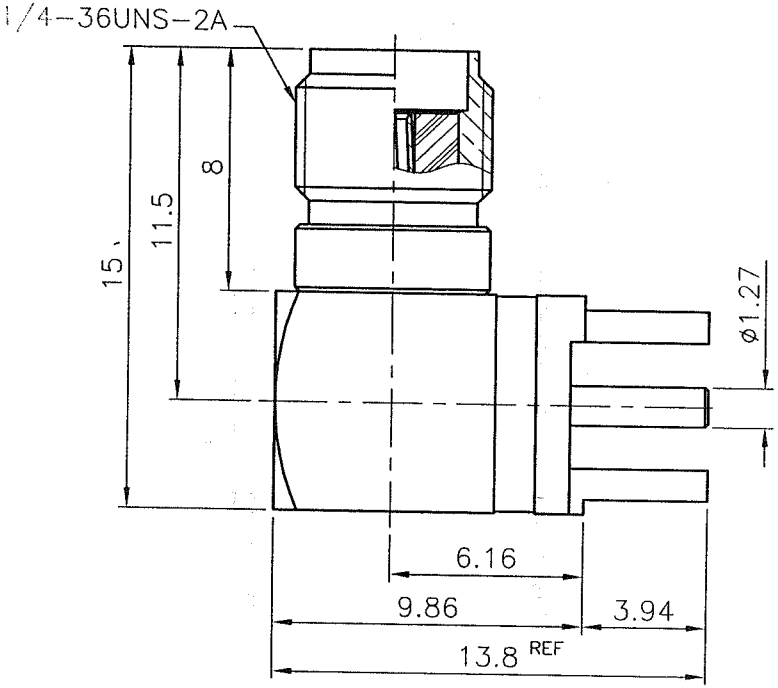
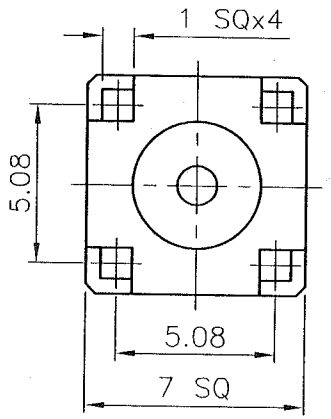
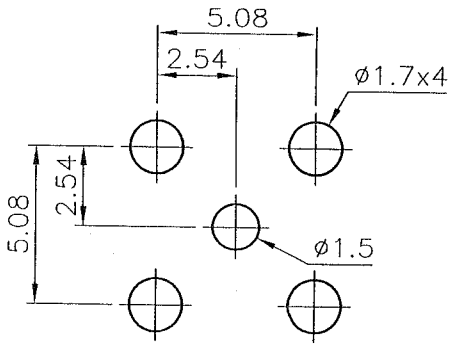
REVISIONS		
ISS	SYMBOL	DESCRIPTION\DATE
		由R7844-BGTG 型號轉來\02/26/07'
		更正 CONTACT PIN 材質\03/15/07'

FOR CUSTOMER

REMARK: RoHS COMPLIANT
(符合 RoHS)







P.C.B. LAYOUT
(印刷電路板配置)

NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)
1. BRASS PER QQ-B-626
2. GOLD PL 3 MIN OVER NICKEL PL 70 MIN THICK OVER COPPER STRIKE
3. GOLD PL 30 MIN OVER NICKEL PL 70 MIN THICK OVER COPPER STRIKE
4. TEFLON MIL-P-19468
5. PHOSPHOR BRONZE PER QQ-B-750

出圖
96.3.16
開發設計部

NO.	DESCRIPTION	MATERIAL	FINISH	Q'TY	DRAWING NO.
	INSULATOR	NOTE 4	WHITE		
	INSULATOR	NOTE 4	WHITE		
	BODY	NOTE 1	NOTE 2		
	CONTACT PIN	NOTE 5	NOTE 3		
	CUBE BODY	NOTE 1	NOTE 2		

DIMENSIONS ARE IN MILLIMETERS
UNLESS OTHERWISE SPECIFIED TOLERANCES
(一般公差)
0.5~6 = ±0.2
>6~30 = ±0.4
>30~120 = ±0.6
>120~315 = ±1
>315~1000 = ±1.6
ANGLES(角度) = ±5°

SCALE 4/1 ISSUE A2

PART NO.

APPROVED DATE 03/15/07'
CHECKED DATE 03/15/07'
DRAWN DATE 03/15/07'

BO-JIANG 帛江科技股份有限公司
BO-JIANG TECHNOLOGY CO., LTD.

TITLE
SMA R/A PCB MOUNT JACK

DRAWING NO. 7865NR502BD001B

FILE NO. Z:\NND\7865\NR\502\001\7865NR502BD001B-A2